



Microprocessor Reset Circuit

SOT-23

Pin Definition:



TS803 TS803R
1. Ground 1. Reset
2. Reset 2. Ground
3. Vcc 3. Vcc

General Description

The TS803/TS803R are microprocessor (μP) supervisory circuit used to monitor the power supplies in μP and digital systems. They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with +5V, +3.3V, +3.0V powered circuits. These circuits perform a single function: they assert a reset signal whenever the VCC supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after VCC has risen above the reset threshold. Reset thresholds suitable for operation with a variety of supply voltages are available. The TS803/TS803R are open –drain outputs. The TS803/TS803R have an active low RESET output, while the TS803/TS803R has an active high RESET output. The reset comparator is designed to ignore fast transients on VCC, and the output guaranteed to be in the correct logic state for VCC down to 1V. Low supply correct makes the TS803/TS803R ideal for use in portable equipment.

Features

- Precision monitoring of +3V, +3.3V & +5V power supply voltage
- Fully specified over temperature
- Available in three output configurations
- Open-Drain RESET low output
- 3uA supply current
- Guaranteed reset valid to Vcc = +1V
- Power supply transient immunity
- No external components

Applications

- Computers
- Controllers
- Intelligent Instruments
- Critical uP and uC power monitoring
- Portable / Battery Power Equipment
- Automotive

Ordering Information

Part No.	Package	Packing
TS803CX <u>x</u> RF	SOT-23	3Kpcs / 7" Reel
TS803RCXx RF	SOT-23	3Kpcs / 7" Reel

Note: \mathbf{x} is the threshold voltage type, option as

TS803 Threshold Voltage

A:4.63V **B**:4.38V **C**:4.00V **D**:3.08V **E**:2.93V **F**:2.63V **G**:2.32V **H**:2.1V

I : 2.0V J : 1.8V K :1.6V

TS803R Threshold Voltage

B: 4.20V **E**: 2.93V **F**: 2.70V Contact factory for additional voltage options.

Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Supply Voltage	V _{CC}	7	V
RESET & (RESET) Open Drain	V_{RESET}	- 0.3 ~ (V _{CC} +0.3)	V
Input Current, V _{CC}	I _{cc}	20	mA
Output Current, RESET	Io	20	mA
Rate of Rise, V _{CC}	V_R	100	V/uS
ESD Classification		В	

Note: Stress above the listed absolute maximum rating may cause permanent damage to the device

HBM B: 2000V~3999V





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Recommended Operating Conditions

Parameter	Symbol	Value	Unit
Supply Voltage	V _{CC}	<5	V
Operating Ambient Temperature Range	T _A	-40 ~ +85	°C
Operating Junction Temperature Range	TJ	-40 ~ +125	°C
Storage Temperature Range	T _{STG}	-65 ~ +150	°C
Thermal Resistance	Ѳјс	325	°C/W
Power Dissipation	P _D	350	mW
Lead Soldering Temperature (260°C)	T_LEAD	10	S

Electrical Characteristics Ta=25°C, unless otherwise specified.

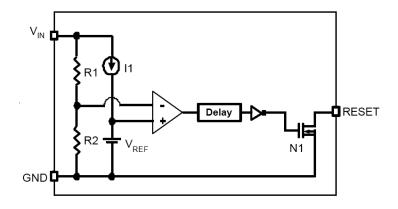
Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Input Supply Voltage	Ta=-40°C~+85°C	V _{CC}	1.0		5.5	V
Supply Current	V _{CC} ≤ V _{TH} * 1.1	I _{CC}			3	
	$V_{IN} = 3V$, Ta=-40°C~+85°C				5	uA
D (T)		V_{TH}	0.985		1.015	
Reset Threshold			V _{TH}		V _{TH}	V
Reset Threshold		V _{TH}	0.97		1.02	
(Full temperature range)			V _{TH}		V _{TH}	V
Reset Threshold		.,			400	,00
Temperature Coefficient		V_{TH}	3-0	50	160	ppm/°C
V _{CC} to Reset Delay	$V_{CC} = V_{TH}$ to $(V_{TH} - 100$ mV $)$	_		40		uS
Reset Active Timeout Period	Ta=-40°C~+85°C	T _{DELAY}	0.5	1.5	5	mS
RESET Output Voltage Low	$V_{CC} < V_{TH(MIN)}$, $I_{SINK} = 1.2 \text{mA}$,	V _{OL}			0.5	V
	V _{CC} > V _{TH(MAX)} , I _{SOURCE} =500uA					
RESET Output Voltage High	V _{CC} > 1.8V					
	V _{CC} > V _{TH(MAX)} , I _{SOURCE} =150uA,	V _{OH}	0.8 V _{CC}			V
	1.8V >= V _{CC} > 1V					

Note 1: The data based on V_{TH} = 2.7V part type. Note 2: Guaranteed by Design



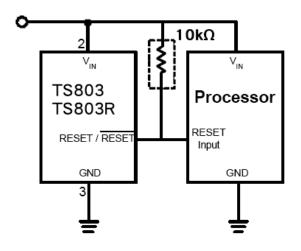


Function Block

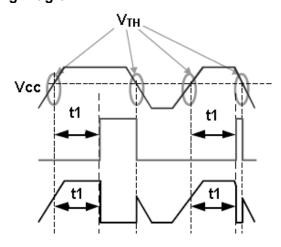


Function Description

Typical Application Circuit



Timing Diagram



Electrical Characteristics Curve

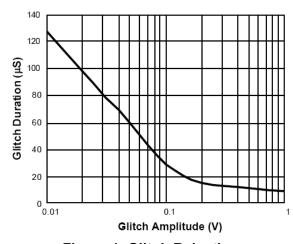


Figure 1. Glitch Rejection

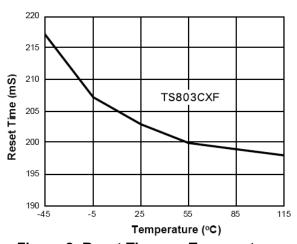


Figure 2. Reset Time vs. Temperature





Electrical Characteristics Curve (Continue)

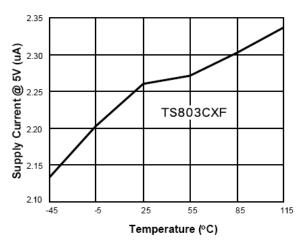


Figure 3. lin vs. Temperature

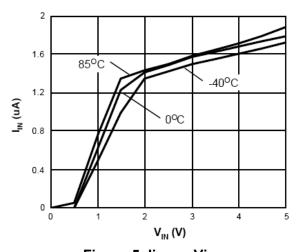


Figure 5. lin vs. Vin

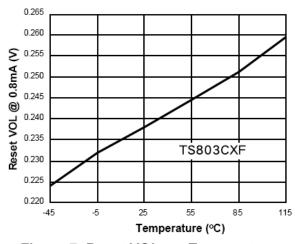


Figure 7. Reset VOL vs. Temperature

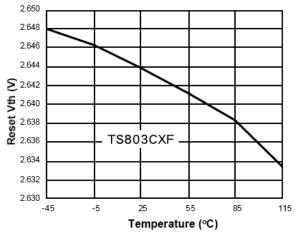


Figure 4. Reset Vth vs. Temperature

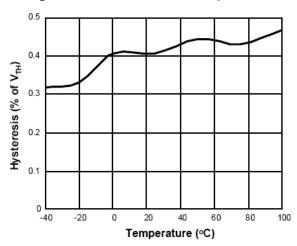
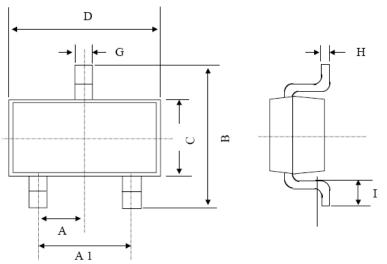


Figure 6. Threshold Hysteresis vs. Temperature

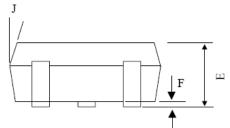




SOT-23 Mechanical Drawing



SOT-23 DIMENSION					
DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX.	
Α	0.95	BSC	0.037 BSC		
A1	1.9 I	BSC	0.074	0.074 BSC	
В	2.60	3.00	0.102	0.118	
С	1.40	1.70	0.055	0.067	
D	2.80	3.10	0.110	0.122	
Е	1.00	1.30	0.039	0.051	
F	0.00	0.10	0.000	0.004	
G	0.35	0.50	0.014	0.020	
Н	0.10	0.20	0.004	0.008	
I	0.30	0.60	0.012	0.024	
J	5°	10°	5°	10°	



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